# **PRODUCT SPECIFICATION**





- < >> Preliminary Specification
- < >> Finally Specification

CUSTOMER'S APPROVAL							
CUSTOMER:	CUSTOMER:						
SIGNATURE: DATE:							

APPROVED	РМ	PD	PREPARED
ВҮ	REVIEWED	REVIEWED	BY
TFT S. G. H			TFT L. Q 20220815

knitter-switch

# **Revision History**

Revision	Date	Originator	Detail	Remarks
1.0	2022.08.15	LQ	Initial Release	

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## 1. General Description

The specification is a transmissive type color active matrix liquid crystal display (LCD) which uses amorphous thin film transistor (TFT) as switching devices. This product is composed of a TFT-LCD panel, driver ICs, and a backlight unit.

### 2. Module Parameter

Features	Details	Unit
Display Size(Diagonal)	2.76"	
LCD type	IPS TFT	
Display Mode	Transmissive /Normally black	
Resolution	480 RGB x 480	Pixels
View Direction	FULL VIEW	Best Image
Module Outline	73.032(H) x 76.478 (V) x2.2 (T) (Note1)	mm
Active Area	70.128(H) x 70.128(V)	mm
Pixel Size	146.1(H) x 146.1(V)	Um
Pixel Arrangement	RGB Vertical stripe	
Display Colors	16.7M	
Interface	3 wire SPI + 18bit RGB interface	
With or without touch panel	Without	
Driver IC	ST7701S	-
Operating Temperature	-20~70	°C
Storage Temperature	-30~80	°C
Weight	20	g

Note 1: Exclusive hooks, posts, FFC/FPC tail etc.

## 3. Absolute Maximum Ratings

GND=0V, Ta=25°C

ltem	Symbol	Min.	Max.	Unit
Supply Voltage	VCI	-0.3	4.6	V
Storage temperature	T <sub>STG</sub>	-30	+80	°C
Operating temperature	T <sub>OP</sub>	-20	+70	°C

Note 1: If Ta below 50°C, the maximal humidity is 90%RH, if Ta over 50°C, absolute humidity should be less than 60%RH.

Note 2: The response time will be extremely slow when the operating temperature is around -10 $^{\circ}$ C, and the back ground will become darker at high temperature operating.

## 4. DC Characteristics

ltem	Symbol	Min.	Тур.	Max.	Unit
Supply Voltage	VCI	2.5	2.8	3.3	V
Logic Low input voltage	V <sub>IL</sub>	GND	-	0.3*VCI	V
Logic High input voltage	V <sub>IH</sub>	0.7*VCI	1	VCI	V
Logic Low output voltage	V <sub>OL</sub>	GND	-	0.2*VCI	V
Logic High output voltage	V <sub>OH</sub>	0.8*VCI	-	VCI	V
Current Consumption All white	I <sub>VCI</sub>	-	25	-	mA

# 5. Backlight Characteristic

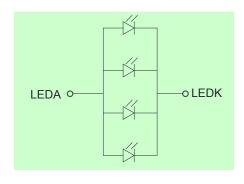
## 5.1. Backlight Characteristics

Item	Symbol	Condition	Min.	Тур.	Max.	Unit
Forward Voltage	VF	Ta=25 °C, I <sub>F</sub> =20mA/LED	2.7	3.0	3.3	V
Forward Current	lF	Ta=25 °C, V <sub>F</sub> =3.0V/LED	-	80	-	mA
Power dissipation	Pb		-	240	-	mW
Uniformity	Avg		-	80	-	%
LED working life(25℃)	-		-	30,000	-	Hrs
Drive method	Constant current					
LED Configuration	4 White LEDs ( 4 groups in parallel)					

Note1: LED life time defined as follows: The final brightness is at 50% of original brightness.

The environmental conducted under ambient air flow, at Ta=25 $\pm2$  °C,60%RH $\pm5$ %, I<sub>F</sub>=20mA/LED.

## 5.2. Backlighting circuit



# 6. Optical Characteristics

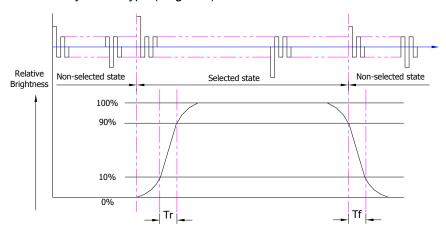
## 6.1. Optical Characteristics

Ta=25°C, VCI=2.8V

	Item		Symbol	Condition	S	pecificati	on	Unit
	iten	l	Symbol	Condition	Min.	Тур.	Max.	Unit
	Luminance on							
) (a)	TFT( $I_f$ =20mA/LED)		Lv	Normally	184	230	-	cd/m²
l o	Contrast ratio	(See 6.3)	CR	viewing angle $\theta x = \phi y = 0^{\circ}$	1000	1200	-	
Backlight On (Transmissive Mode)	•	Response time (See 6.2)		θx = ψΥ =0*	-	35	40	ms
Sm		Red XR YR Chromaticity Green YG		0.597	0.647	0.697		
<u>a</u>	ra		YR		0.263	0.313	0.363	
ا ك	Chromoticity		XG		0.246	0.296	0.346	
Ō	Transmissive		YG		0.565	0.615	0.665	
ght	(See 6.5)	Blue	Хв		0.083	0.133	0.183	
품	(566 0.5)	Diue	YB		0.026	0.076	0.126	
Ba		White	Xw		0.237	0.287	0.337	
		VVIIILE	Yw		0.298	0.348	0.398	
	Viewing Angle	Horizontol	θх+		80	85	1	
		gle Horizontal θx-	θх-	Center CR≥10	80	85	-	Dog
	(See 6.4)	(See 6.4)	фҮ+	Center CR210	80	85	-	Deg.
		Vertical	φY-		80	85		
	NTSC Ratio	(Gamut)			60	65	-	%

## 6.2. Definition of Response Time

#### 6.2.1. Normally Black Type (Negative)

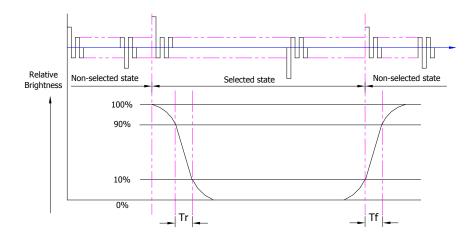


Tr is the time it takes to change form non-selected stage with relative luminance 10% to selected state with relative luminance 90%;

Tf is the time it takes to change from selected state with relative luminance 90% to non-selected state with relative luminance 10%.

Note: Measuring machine: LCD-5100

#### 6.2.2. Normally White Type (Positive)



Tr is the time it takes to change form non-selected stage with relative luminance 90% to selected state with relative luminance 10%;

Tf is the time it takes to change from selected state with relative luminance 10% to non-selected state with relative luminance 90%;

Note: Measuring machine: LCD-5100 or EQUI

#### 6.3. Definition of Contrast Ratio

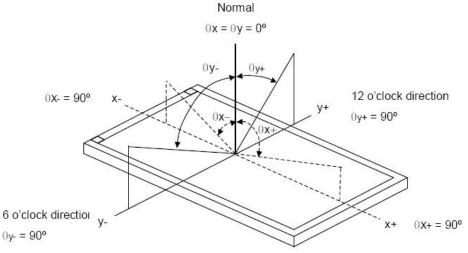
Contrast is measured perpendicular to display surface in reflective and transmissive mode.

The measurement condition is:

Measuring Equipment	Eldim or Equivalent
Measuring Point Diameter	3mm//1mm
Measuring Point Location	Active Area centre point
Toot nottorn	A: All Pixels white
Test pattern	B: All Pixel black
Contrast setting	Maximum

Definitions: CR (Contrast) = Luminance of White Pixel / Luminance of Black Pixel

## 6.4. Definition of Viewing Angles

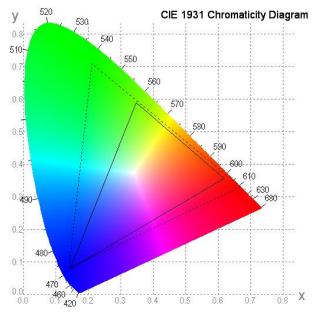


Measuring machine: LCD-5100 or EQUI

#### 6.5. Definition of Color Appearance

R,G,B and W are defined by (x, y) on the IE chromaticity diagram NTSC=area of RGB triangle/area of NTSC triangleX100%

Measuring picture: Red, Green, Blue and White (Measuring machine: BM-7)

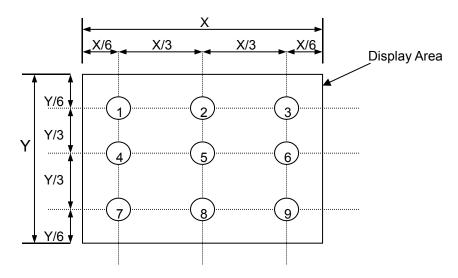


#### 6.6. Definition of Surface Luminance, Uniformity and Transmittance

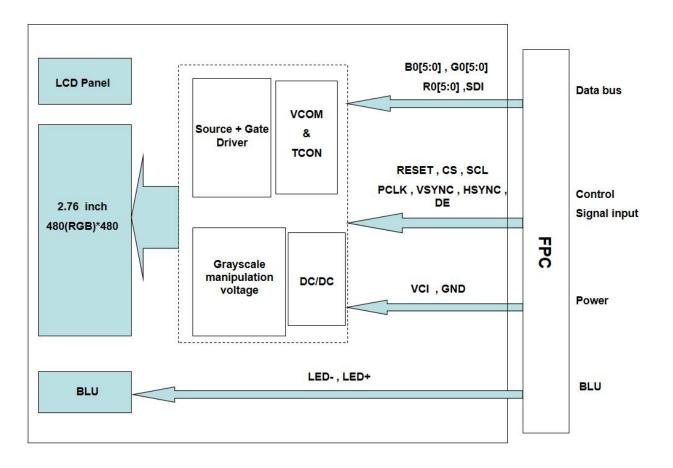
Using the transmissive mode measurement approach, measure the white screen luminance of the display panel and backlight.

- 6.6.1. Surface Luminance:  $L_V$  = average ( $L_{P1}$ : $L_{P9}$ )
- 6.6.2. Uniformity = Minimal  $(L_{P1}:L_{P9})$  / Maximal  $(L_{P1}:L_{P9})$  \* 100%
- 6.6.3. Transmittance =  $L_V$  on LCD /  $L_V$  on Backlight \* 100%

Note: Measuring machine: BM-7



# 7. Block Diagram and Power Supply



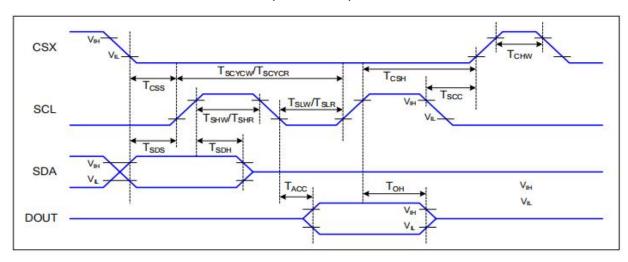
# 8. Interface Pins Definition

No.	Symbol	Function	Remark
1	LED+	Anode for back light driver voltage	
2	LED-	Cathode for back light driver voltage	
3	LED-	Cathode for back light driver voltage	
4	GND	Ground	
5	VCI	Power supply	
6	RESET	Reset input pin	
7	NC	No Connect	
8	NC	No Connect	
9	SDI	Serial data input pin	
10	SCL	Serial Clock	
11	CS	Chip select signal	
12	PCLK	Pixel clock signal	
13	DE	Data Enable signal	
14	VSYNC	Vertical Sync Signal	
15	HSYNC	Horizontal Sync Signal	
16	B0	Blue Data bus	
17	B1	Blue Data bus	
18	B2	Blue Data bus	
19	B3	Blue Data bus	
20	B4	Blue Data bus	
21	B5	Blue Data bus	
22	G0	Green Data bus	
23	G1	Green Data bus	
24	G2	Green Data bus	
25	G3	Green Data bus	
26	G4	Green Data bus	
27	G5	Green Data bus	
28	R0	Red Data bus	
29	R1	Red Data bus	
30	R2	Red Data bus	
31	R3	Red Data bus	
32	R4	Red Data bus	
33	R5	Red Data bus	
34	GND(CTP)	No Connect	
35	NC(TP INT)	No Connect	
36	NC(TP SDA)	No Connect	
37	NC(TP-SCL)	No Connect	
38	NC(TP-RESET)	No Connect	
39	NC(TP-VCC)	No Connect	

40	NC	No Connect	

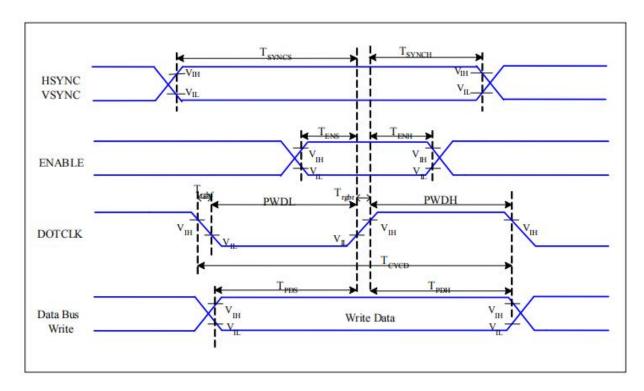
# 9. AC Characteristics

## 9.1. Serial Interface Characteristics (3-line serial):



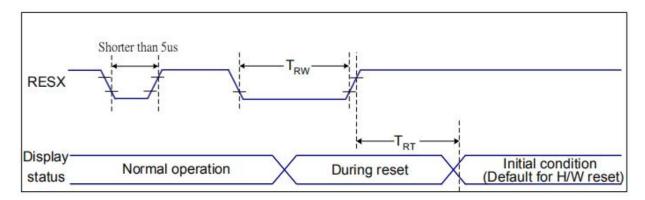
Signal	Symbol	Parameter	Min	Max	Unit	Description
	T <sub>CSS</sub>	Chip select setup time (write)	15		ns	
	T <sub>CSH</sub>	Chip select hold time (write)	15		ns	
CSX	T <sub>CSS</sub>	Chip select setup time (read)	60		ns	
	Tscc	Chip select hold time (read)	60		ns	
	T <sub>CHW</sub>	Chip select "H" pulse width	40		ns	
	T <sub>SCYCW</sub>	Serial clock cycle (Write)	66		ns	
	Tshw	SCL "H" pulse width (Write)	15		ns	
SCL	T <sub>SLW</sub>	SCL "L" pulse width (Write)	15		ns	
SCL	TSCYCR	Serial clock cycle (Read)	150		ns	
	T <sub>SHR</sub>	SCL "H" pulse width (Read)	60		ns	
	T <sub>SLR</sub>	SCL "L" pulse width (Read)	60		ns	
SDA	T <sub>SDS</sub>	Data setup time	10		ns	_
(DIN)	T <sub>SDH</sub>	Data hold time	10		ns	

## 9.2. RGB Interface Characteristics



Signal	Symbol	pol Parameter		MAX	Unit	Description
HSYNC, VSYNC	Tsyncs VSYNC, HSYNC Setup Time		5		ns	
ENABLE	T <sub>ENS</sub>	Enable Setup Time	5	-	ns	
ENABLE	TENH	Enable Hold Time		-	ns	
	PWDH	DOTCLK High-level Pulse Width	15	-	ns	
DOTCLK	PWDL	DOTCLK Low-level Pulse Width	15	-	ns	
DOTCLK	T <sub>CYCD</sub>	DOTCLK Cycle Time	33	-	ns	
	Trghr, Trghf	DOTCLK Rise/Fall time	120	15	ns	
DB	T <sub>PDS</sub>	PD Data Setup Time	5	-	ns	
	T <sub>PDH</sub>	PD Data Hold Time	5	-	ns	

#### 9.3. Reset Timing



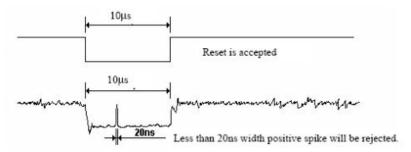
Related Pins	Symbol	Parameter	MIN	MAX	Unit
RESX	TRW	Reset pulse duration	10	- 1	us
	TOT	D 1	-	5 (Note 1, 5)	ms
	TRT	Reset cancel		120(Note 1, 6, 7)	ms

#### Notes:

- The reset cancel includes also required time for loading ID bytes, VCOM setting and other settings from NVM (or similar device) to registers. This loading is done every time when there is HW reset cancel time (tRT) within 5 ms after a rising edge of RESX.
  - 2. Spike due to an electrostatic discharge on RESX line does not cause irregular system reset according to the table below:

RESX Pulse	Action
Shorter than 5us	Reset Rejected
Longer than 9us	Reset
Between 5us and 9us	Reset starts

- 3. During the Resetting period, the display will be blanked (The display is entering blanking sequence, which maximum time is 120 ms, when Reset Starts in Sleep Out –mode. The display remains the blank state in Sleep In –mode.) and then return to Default condition for Hardware Reset.
  - 4. Spike Rejection also applies during a valid reset pulse as shown below:



- 5. When Reset applied during Sleep In Mode.
- 6. When Reset applied during Sleep Out Mode.
- It is necessary to wait 5msec after releasing RESX before sending commands. Also Sleep Out command cannot be sent for 120msec.

## 10. Quality Assurance

#### 10.1.Purpose

This standard for Quality Assurance assures the quality of LCD module products supplied to customer.

#### 10.2.Standard for Quality Test

10.2.1. Sampling Plan:

GB2828.1-2012

Single sampling, general inspection level II

10.2.2. Sampling Criteria:

Visual inspection: AQL 1.5 Electrical functional: AQL 0.65.

10.2.3. Reliability Test:

Detailed requirement refer to Reliability Test Specification.

#### 10.3. Nonconforming Analysis & Disposition

- 10.3.1. Nonconforming analysis:
  - 10.3.1.1. Customer should provide overall information of non-conforming sample for their complaints.
  - 10.3.1.2. After receipt of detailed information from customer, the analysis of nonconforming parts usually should be finished in one week.
  - 10.3.1.3. If cannot finish the analysis on time, customer will be notified with the progress status.
- 10.3.2. Disposition of nonconforming:
  - 10.3.2.1. Non-conforming product over PPM level will be replaced.
  - 10.3.2.2. The cause of non-conformance will be analyzed. Corrective action will be discussed and implemented.

#### 10.4. Agreement Items

Shall negotiate with customer if the following situation occurs:

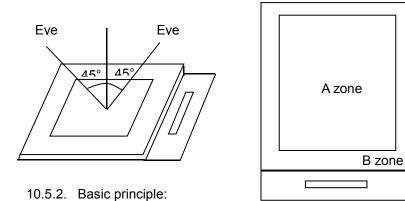
- 10.4.1. There is any discrepancy in standard of quality assurance.
- 10.4.2. Additional requirement to be added in product specification.
- 10.4.3. Any other special problem.

### 10.5. Standard of the Product Visual Inspection

- 10.5.1. Appearance inspection:
  - 10.5.1.1. The inspection must be under illumination about 1000 1500 lx, and the distance of view must be at 30cm ± 2cm.

10.5.1.2. The viewing angle should be 45° from the vertical line without reflection light or follows customer's viewing angle specifications.

10.5.1.3. Definition of area: A Zone: Active Area, B Zone: Viewing Area,

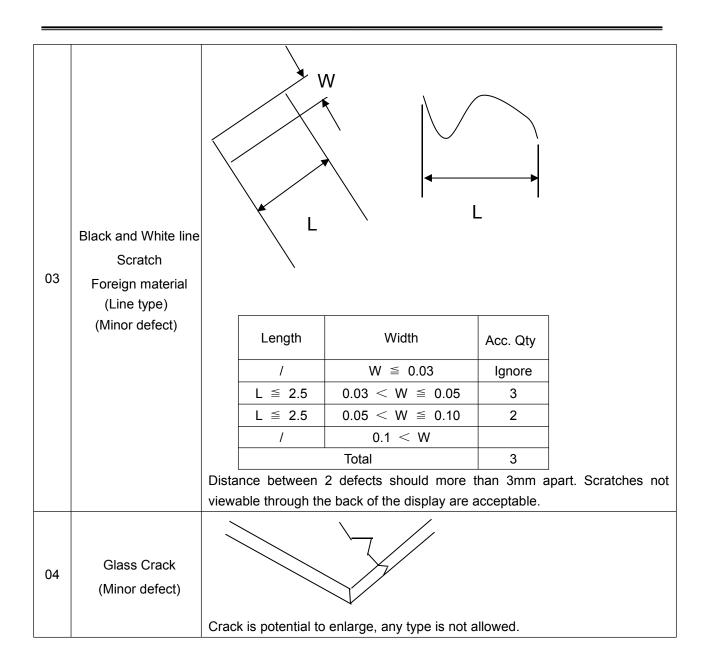


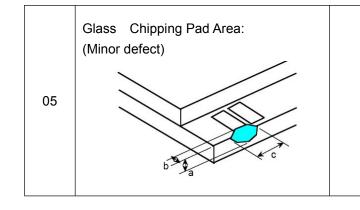
10.5.2.1. A set of sample to indicate the limit of acceptable quality level must be discussed by both us and customer when there is any dispute happened.

10.5.2.2. New item must be added on time when it is necessary.

## 10.6.Inspection Specification

No.	Item	Criteria (Unit: mm)					
01	Black / White spot Foreign material (Round type) Pinholes Stain Particles inside cell. (Minor defect)	φ= (a + b) /2	Area Size  φ≤0.10  0.10<φ≤0.15  0.15<φ≤0.25  0.25<φ  Total	Acc. Qty  Ignore  2  1  0  2 no include φ≤ 0.10			
02	Electrical Defect (Minor defect)	Distance between 2 defects should  Display Are  Bright dot  Dark dot  N≤2  Total dot  Not visible to the should of the should o	Total  0  N≤2  N≤2  through 5% ND filters.	Note1 Note2  ords to item 1.			





Length and Width	Acc. Qty			
c > 3.0, b< 1.0	1			
c< 3.0, b< 1.0	3			
a <glass td="" thickness<=""></glass>				

	Glass Chipping Rear of Pad Area:					
	(Minor defect)	_				
		Length and Width		Acc. Qty		
06			c > 3.0, b< 1.0	1		
00			c< 3.0, b< 1.0	2		
			c< 3.0, b< 0.5	4		
	c c		a <glass td="" thic<=""><td>kness</td><td></td></glass>	kness		
	a					
	Glass Chipping Except Pad Area:					
	(Minor defect)					
			Length and Width	Acc. Qty		
			c > 3.0, b< 1.0	1		
07			c< 3.0, b< 1.0	2		
			c< 3.0, b< 0.5	4		
	b **		a <glass td="" thic<=""><td>kness</td><td></td></glass>	kness		
	₩ Çc	_				
	a 🆍					
	Glass Corner Chipping:					
	(Minor defect)					
			Length and Width	Acc. Qty		
			c < 3.0, b< 3.0	Ignore		
08		a <glass td="" thickness<=""></glass>				
	bacc					
	Glass Burr:					
	(Minor defect)					
			Length	Acc. Qty		
			F < 1.0	Ignore		
				3		
		Glass	burr don't affect as	semble and m	nodule	
		dimensi				
09	F					
	F					
	1	1				

	FPC Defect:					
	(Minor defect)		10.1 Dont pipholo width oxw/2			
	a⊸⊧⊬	_	10.1 Dent, pinhole width a <w 3.<="" td=""></w>			
10	$\downarrow \downarrow $	←—	(w: circuitry width.)			
	\ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \		10.2 Open circuit is	unacceptable.		
			10.3 No oxidation, co	ontamination an	d distortion.	
	a——					
			Diameter	Acc. Qty		
	Bubble on Polarizer		φ≤0.20	Ignore		
11			0.20 <φ≤0.30	4		
	(Minor defect)		0.30 <φ≤0.50	1		
			0.50 < φ	None		
			•		1	
			Diameter	Acc. Qty		
	Dent on Polarizer		φ≤0.20	Ignore		
12			0.20 <φ≤0.30	4		
	(Minor defect)		0.30 <φ≤0.50	1		
			0.50 < φ	None		
					-	
13	Bezel	13.1 No rust, distortion on the Bezel.				
		13.2 No visible fin	gerprints, stains or othe	r contamination.	-	
		14.1 No distortion	or contamination on PC	B terminals.		
		14.2 All compon	ents on PCB must sa	me as docume	ented on the	
14	PCB	-				
		BOM/component layout.				
		14.3 Follow IPC-A-600F.				
15	Soldering	Follow IPC-A-610	C standard			
		The below defects	s must be rejected.			
		16.1 Missing verti	cal / horizontal segment	,		
		16.2 Abnormal Display.				
	Florida D. C. C	16.3 No function of				
16	Electrical Defect		eds product specificatio	ns.		
	(Major defect)	16.5 LCD viewing	·			
		16.6 No Backlight	_			
		16.7 Dark Backlig				
		16.8 Touch Panel				

Remark: LCD Panel Broken shall be rejected. Defect out of LCD viewing area is acceptable.

#### 10.7. Classification of Defects

- 10.7.1. Visual defects (Except no / wrong label) are treated as minor defect and electrical defect is major.
- 10.7.2. Two minor defects are equal to one major in lot sampling inspection.

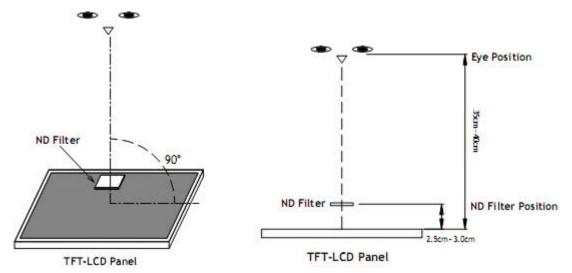
#### 10.8.Identification/marking criteria

Any unit with illegible / wrong /double or no marking/ label shall be rejected.

#### 10.9. Packaging

- 10.9.1. There should be no damage of the outside carton box, each packaging box should have one identical label.
- 10.9.2. Modules inside package box should have compliant mark.
- 10.9.3. All direct package materials shall offer ESD protection.

**Note1**: Bright dot is defined as the defective area of the dot is larger than 50% of one sub-pixel area.



Bright dot: The bright dot size defect at black display pattern. It can be recognized by 2% transparency of filter when the distance between eyes and panel is  $350 \text{mm} \pm 50 \text{mm}$ .

Dark dot: Cyan, Magenta or Yellow dot size defect at white display pattern. It can be recognized by 5% transparency of filter when the distance between eyes and panel is  $350 \text{mm} \pm 50 \text{mm}$ .

**Note2:** Mura on display which appears darker / brighter against background brightness on parts of display area.

# 11. Reliability Specification

No	Item	Condition	Quantity	Criteria
1	High Temperature Operating	70℃, 96Hrs	2	GB/T2423.2 -2008
2	Low Temperature Operating	-20℃, 96Hrs	2	GB/T2423.1 -2008
3	High Humidity Storage	50℃, 90%RH, 96Hrs	2	GB/T2423.3 -2016
4	High Temperature Storage	80℃, 96Hrs	2	GB/T2423.2 -2008
5	Low Temperature Storage	-30℃, 96Hrs	2	GB/T2423.1 -2008
6	Thermal Cycling Test Storage	-20℃, 60min~70℃, 60min, 20 cycles.	2	GB/T2423.22 -2012
7	Packing vibration	Frequency range:10Hz~50Hz Acceleration of gravity:5G X, Y, Z 30 min for each direction.	-	GB/T5170.14 -2009
8	Electrical Static Discharge	Air: $\pm$ 4KV 150pF/330 $\Omega$ 5 times	2	GB/T17626.2
	Liectrical Static Discharge	Contact: $\pm$ 2KV 150pF/330 $\Omega$ 5 times		-2018
9	Drop Test (Packaged)	Height:80 cm,1 corner, 3 edges, 6 surfaces.	-	GB/T2423.8 -1995

Note1. No defection cosmetic and operational function allowable.

Note2. Total current Consumption should be below double of initial value

## 12. Precautions and Warranty

### 12.1.Safety

- 12.1.1. The liquid crystal in the LCD is poisonous. Do not put it in your mouth. If the liquid crystal touches your skin or clothes, wash it off immediately using soap and water.
- 12.1.2. Since the liquid crystal cells are made of glass, do not apply strong impact on them. Handle with care.

#### 12.2. Handling

- 12.2.1. Reverse and use within ratings in order to keep performance and prevent damage.
- 12.2.2. Do not wipe the polarizer with dry cloth, as it might cause scratch. If the surface of the LCD needs to be cleaned, wipe it swiftly with cotton or other soft cloth soaked with petroleum IPA, do not use other chemicals.

#### 12.3.Storage

- 12.3.1. Do not store the LCD module beyond the specified temperature ranges.
- 12.3.2. Strong light exposure causes degradation of polarizer and color filter.

### 12.4. Metal Pin (Apply to Products with Metal Pins)

12.4.1. Pins of LCD and Backlight

12.4.1.1. Solder tip can touch and press on the tip of Pin LEAD during the soldering

12.4.1.2. Recommended Soldering Conditions

Solder Type: Sn96.3~94-Ag3.3~4.3-Cu0.4~1.1

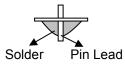
Maximum Solder Temperature: 370 ℃

Maximum Solder Time: 3s at the maximum temperature

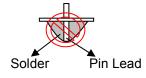
Recommended Soldering Temp: 350±20 ℃

Typical Soldering Time: ≤3s

12.4.1.3. Solder Wetting



Recommended



Not Recommended

#### 12.4.2. Pins of EL

- 12.4.2.1. Solder tip can touch and press on the tip of EL leads during soldering.
- 12.4.2.2. No Solder Paste on the soldering pad on the motherboard is recommended.
- 12.4.2.3. Recommended Soldering Conditions

Solder type: Nippon Alimit Leadfree SR-34, size 0.5mm

Recommended Solder Temperature: 270~290 ℃

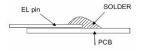
Typical Soldering Time: ≤2s

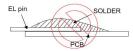
Minimum solder distance from EL lamp (body):2.0mm

12.4.2.4. No horizontal press on the EL leads during soldering.

12.4.2.5. 180° bend EL leads three times is not allowed.

#### 12.4.2.6. Solder Wetting





Recommended

Not Recommended

12.4.2.7. The type of the solder iron:





Recommended

Not Recommended

12.4.2.8. Solder Pad



#### 12.5. Operation

- 12.5.1. Do not drive LCD with DC voltage
- 12.5.2. Response time will increase below lower temperature
- 12.5.3. Display may change color with different temperature
- 12.5.4. Mechanical disturbance during operation, such as pressing on the display area, may cause the segments to appear "fractured".
- 12.5.5. Do not connect or disconnect the LCM to or from the system when power is on.
- 12.5.6. Never use the LCM under abnormal condition of high temperature and high humidity.
- 12.5.7. Module has high frequency circuits. Sufficient suppression to the electromagnetic interface shall be done by system manufacturers. Grounding and shielding methods may be important to minimize the interference.
- 12.5.8. Do not display the fixed pattern for long time (we suggest the time not longer than one hour) because it will develop image sticking due to the TFT structure.

#### 12.6. Static Electricity

- 12.6.1. CMOS LSIs are equipped in this unit, so care must be taken to avoid the electro-static charge, by ground human body, etc.
- 12.6.2. The normal static prevention measures should be observed for work clothes and benches.
- 12.6.3. The module should be kept into anti-static bags or other containers resistant to static for storage.

#### 12.7. Limited Warranty

- 12.7.1. Our warranty liability is limited to repair and/or replacement. We will not be responsible for any consequential loss.
- 12.7.2. If possible, we suggest customer to use up all modules in six months. If the module storage time over twelve months, we suggest that recheck it before the module be used.
- 12.7.3. After the product shipped, any product quality issues must be feedback within three months, otherwise, we will not be responsible for the subsequent or consequential events.

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TBD

## 14. Outline Drawing

